

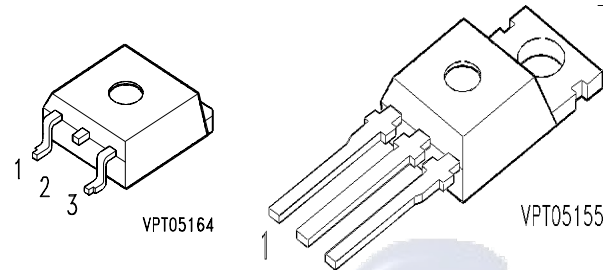
SIEMENS

BUZ 102 SL

SPP47N05L

SIPMOS[®] Power Transistor

- N channel
- Enhancement mode
- Logic Level
- Avalanche-rated
- dv/dt rated
- 175°C operating temperature
- also in SMD available



Pin 1	Pin 2	Pin 3
G	D	S

Type	V _{DS}	I _D	R _{DS(on)}	Package	Ordering Code
BUZ 102 SL	55 V	47 A	0.028 Ω	TO-220 AB	Q67040-S4010-A2

Maximum Ratings

Parameter	Symbol	Values	Unit
Continuous drain current	I _D		A
T _C = 25 °C		47	
T _C = 100 °C		33	
Pulsed drain current	I _{Dpuls}		
T _C = 25 °C		188	
Avalanche energy, single pulse	E _{AS}		mJ
I _D = 47 A, V _{DD} = 25 V, R _{GS} = 25 Ω			
L = 222 μH, T _j = 25 °C		245	
Avalanche current, limited by T _{jmax}	I _{AR}	47	A
Avalanche energy, periodic limited by T _{jmax}	E _{AR}	12	mJ
Reverse diode dv/dt	dv/dt		kV/μs
I _S = 47 A, V _{DS} = 40 V, di _F /dt = 200 A/μs			
T _{jmax} = 175 °C		6	
Gate source voltage	V _{GS}	± 14	V
Power dissipation	P _{tot}		W
T _C = 25 °C		120	

Maximum Ratings

Parameter	Symbol	Values	Unit
Operating temperature	T_j	-55 ... + 175	°C
Storage temperature	T_{stg}	-55 ... + 175	
Thermal resistance, junction - case	R_{thJC}	≤ 1.25	K/W
Thermal resistance, junction - ambient	R_{thJA}	≤ 62	
IEC climatic category, DIN IEC 68-1		55 / 175 / 56	

Electrical Characteristics, at $T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Static Characteristics					
Drain- source breakdown voltage $V_{GS} = 0\text{ V}$, $I_D = 0.25\text{ mA}$, $T_j = 25\text{ }^{\circ}\text{C}$	$V_{(BR)DSS}$	55	-	-	V
Gate threshold voltage $V_{GS}=V_{DS}$, $I_D = 90\text{ }\mu\text{A}$	$V_{GS(th)}$	1.2	1.6	2	
Zero gate voltage drain current $V_{DS} = 50\text{ V}$, $V_{GS} = 0\text{ V}$, $T_j = -40\text{ }^{\circ}\text{C}$ $V_{DS} = 50\text{ V}$, $V_{GS} = 0\text{ V}$, $T_j = 25\text{ }^{\circ}\text{C}$ $V_{DS} = 50\text{ V}$, $V_{GS} = 0\text{ V}$, $T_j = 150\text{ }^{\circ}\text{C}$	I_{DSS}	- - -	- 0.1 -	0.1 1 100	μA
Gate-source leakage current $V_{GS} = 20\text{ V}$, $V_{DS} = 0\text{ V}$	I_{GSS}	-	10	100	nA
Drain-Source on-resistance $V_{GS} = 4.5\text{ V}$, $I_D = 33\text{ A}$ $V_{GS} = 10\text{ V}$, $I_D = 33\text{ A}$	$R_{DS(on)}$	- -	0.022 0.014	0.028 0.018	Ω

Electrical Characteristics, at $T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Dynamic Characteristics					
Transconductance $V_{DS} \geq 2 * I_D * R_{DS(on)max}$, $I_D = 33\text{ A}$	g_{fs}	10	-	-	S
Input capacitance $V_{GS} = 0\text{ V}$, $V_{DS} = 25\text{ V}$, $f = 1\text{ MHz}$	C_{iss}	-	1380	1730	pF
Output capacitance $V_{GS} = 0\text{ V}$, $V_{DS} = 25\text{ V}$, $f = 1\text{ MHz}$	C_{oss}	-	410	515	
Reverse transfer capacitance $V_{GS} = 0\text{ V}$, $V_{DS} = 25\text{ V}$, $f = 1\text{ MHz}$	C_{rss}	-	230	290	
Turn-on delay time $V_{DD} = 30\text{ V}$, $V_{GS} = 4.5\text{ V}$, $I_D = 47\text{ A}$ $R_G = 3.6\text{ }\Omega$	$t_{d(on)}$	-	15	25	ns
Rise time $V_{DD} = 30\text{ V}$, $V_{GS} = 4.5\text{ V}$, $I_D = 47\text{ A}$ $R_G = 3.6\text{ }\Omega$	t_r	-	30	45	
Turn-off delay time $V_{DD} = 30\text{ V}$, $V_{GS} = 4.5\text{ V}$, $I_D = 47\text{ A}$ $R_G = 3.6\text{ }\Omega$	$t_{d(off)}$	-	30	45	
Fall time $V_{DD} = 30\text{ V}$, $V_{GS} = 4.5\text{ V}$, $I_D = 47\text{ A}$ $R_G = 3.6\text{ }\Omega$	t_f	-	20	30	
Gate charge at threshold $V_{DD} = 40\text{ V}$, $I_D = 0.1\text{ A}$, $V_{GS} = 0\text{ to }1\text{ V}$	$Q_{g(th)}$	-	2	3	nC
Gate charge at 5.0 V $V_{DD} = 40\text{ V}$, $I_D = 47\text{ A}$, $V_{GS} = 0\text{ to }5\text{ V}$	$Q_{g(5)}$	-	35	55	
Gate charge total $V_{DD} = 40\text{ V}$, $I_D = 47\text{ A}$, $V_{GS} = 0\text{ to }10\text{ V}$	$Q_{g(total)}$	-	60	90	
Gate plateau voltage $V_{DD} = 40\text{ V}$, $I_D = 47\text{ A}$	$V_{(plateau)}$	-	4.1	-	V

SIEMENS**BUZ 102 SL****SPP47N05L****Electrical Characteristics, at $T_j = 25^\circ\text{C}$, unless otherwise specified**

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Reverse Diode					
Inverse diode continuous forward current $T_C = 25\text{ }^{\circ}\text{C}$	I_S	-	-	47	A
Inverse diode direct current,pulsed $T_C = 25\text{ }^{\circ}\text{C}$	I_{SM}	-	-	188	
Inverse diode forward voltage $V_{GS} = 0\text{ V}, I_F = 94\text{ A}$	V_{SD}	-	1.1	1.7	V
Reverse recovery time $V_R = 30\text{ V}, I_F=I_S, di_F/dt = 100\text{ A}/\mu\text{s}$	t_{rr}	-	75	115	ns
Reverse recovery charge $V_R = 30\text{ V}, I_F=I_S, di_F/dt = 100\text{ A}/\mu\text{s}$	Q_{rr}	-	0.15	0.25	μC

Electrónica S.A. de C.V.

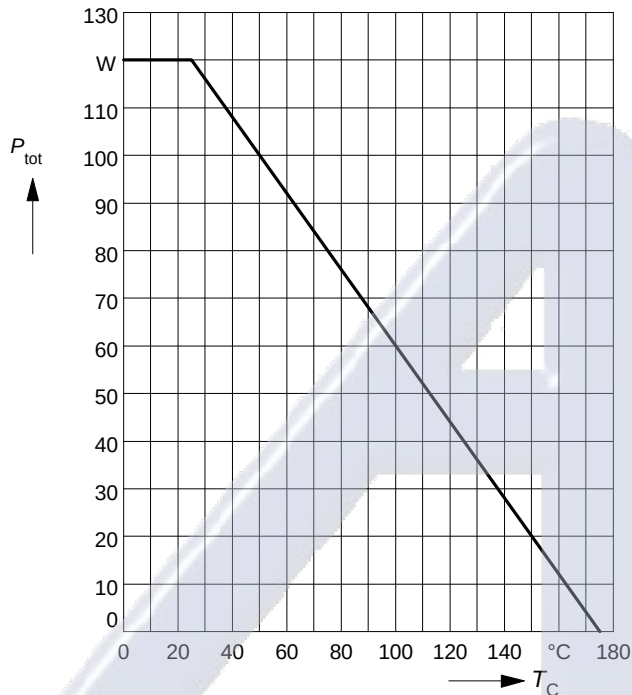
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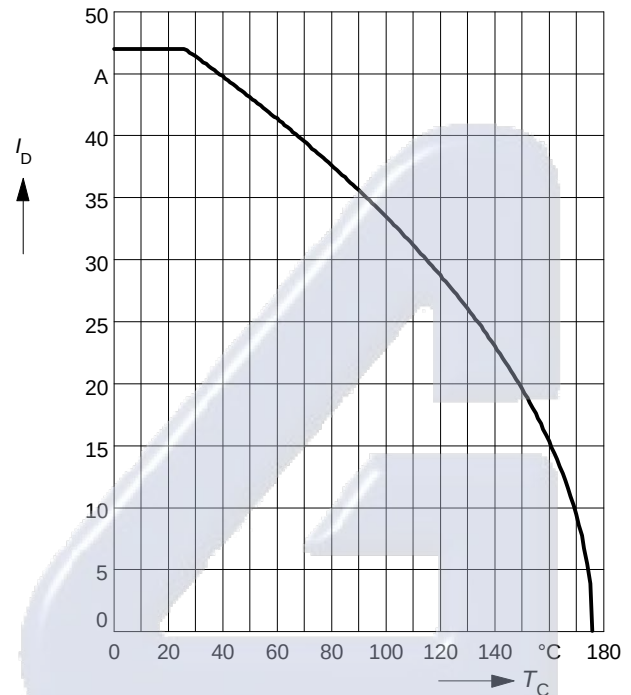
Power dissipation

$$P_{\text{tot}} = f(T_C)$$



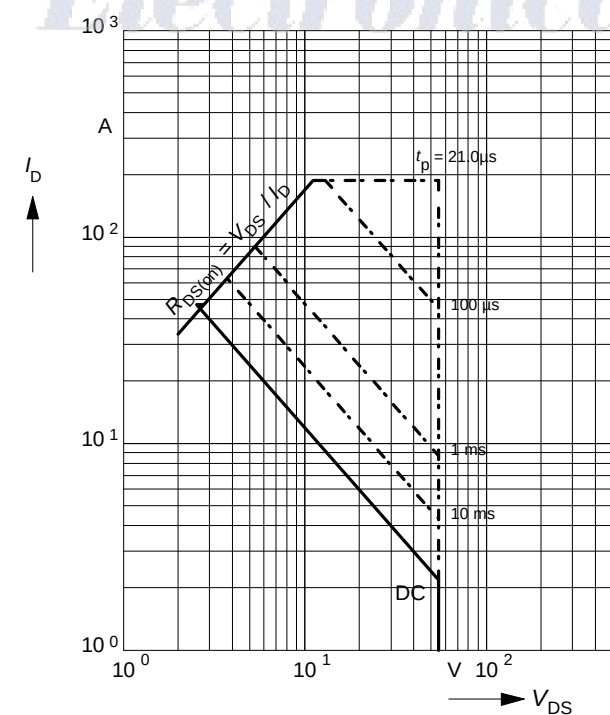
Drain current

$$I_D = f(T_C)$$

parameter: $V_{GS} \geq 4 \text{ V}$ 

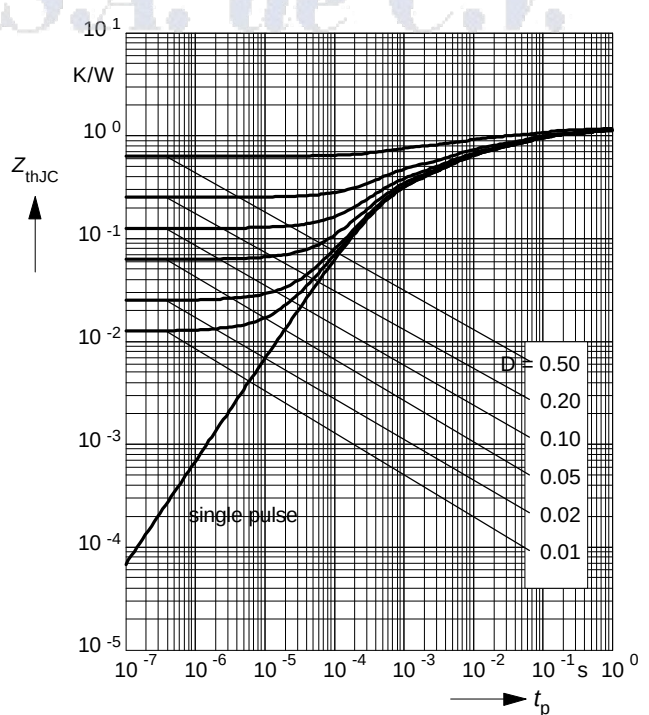
Safe operating area

$$I_D = f(V_{DS})$$

parameter: $D = 0$, $T_C = 25^\circ\text{C}$ 

Transient thermal impedance

$$Z_{\text{thJC}} = f(t_p)$$

parameter: $D = t_p / T$ 

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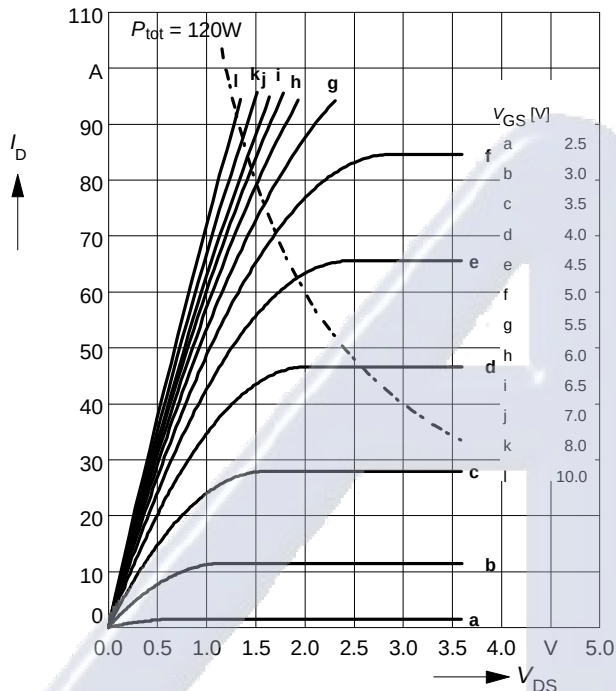
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Typ. output characteristics

$$I_D = f(V_{DS})$$

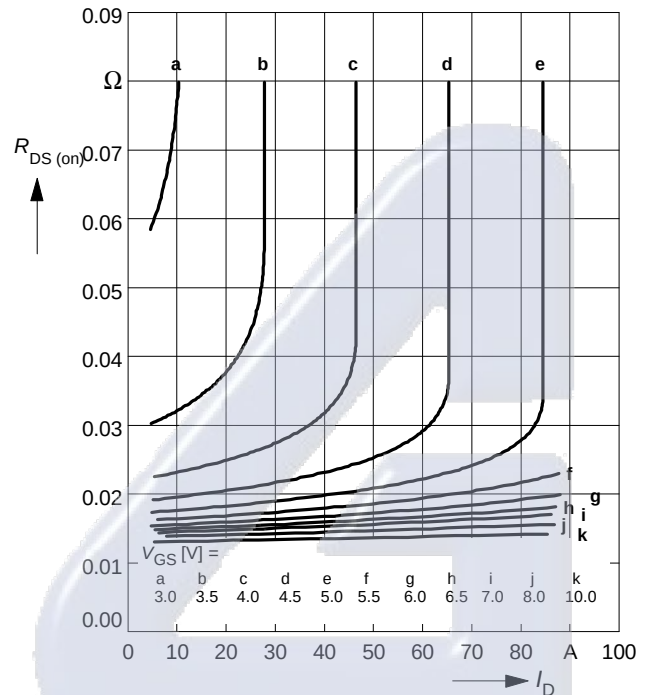
parameter: $t_p = 80 \mu s$, $T_j = 25^\circ C$



Typ. drain-source on-resistance

$$R_{DS(on)} = f(I_D)$$

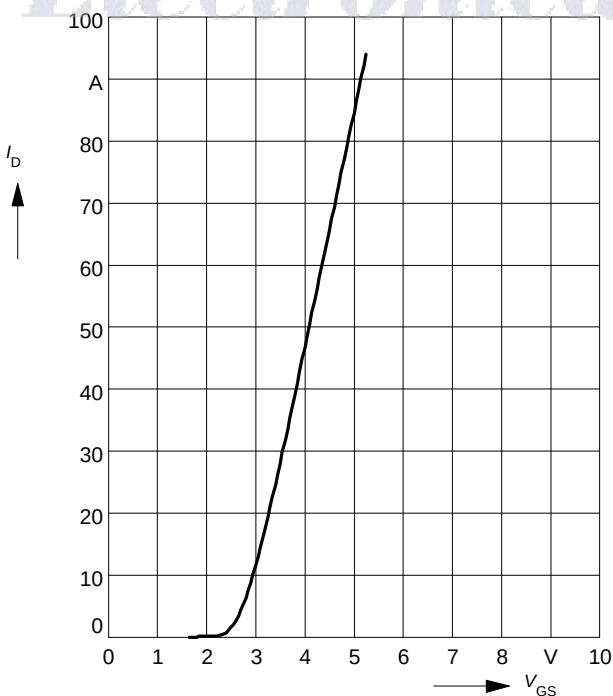
parameter: $t_p = 80 \mu s$, $T_j = 25^\circ C$



Typ. transfer characteristics $I_D = f(V_{GS})$

parameter: $t_p = 80 \mu s$

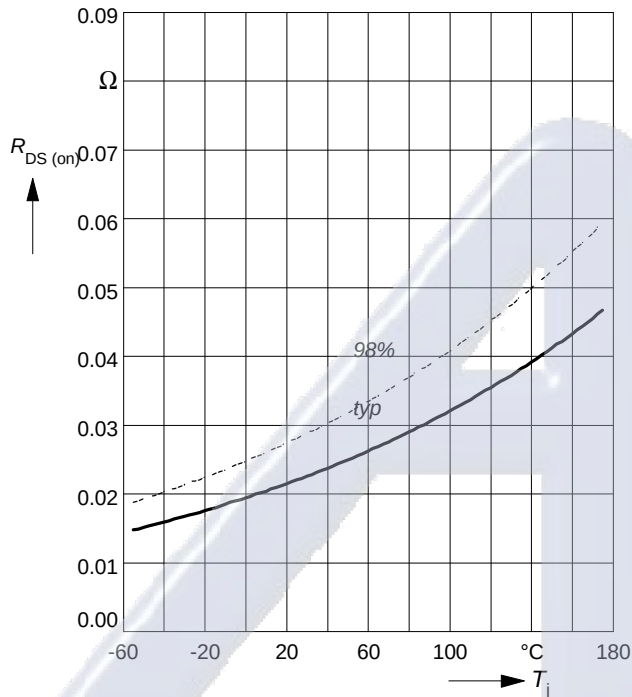
$$V_{DS} \geq 2 \times I_D \times R_{DS(on)max}$$



Drain-source on-resistance

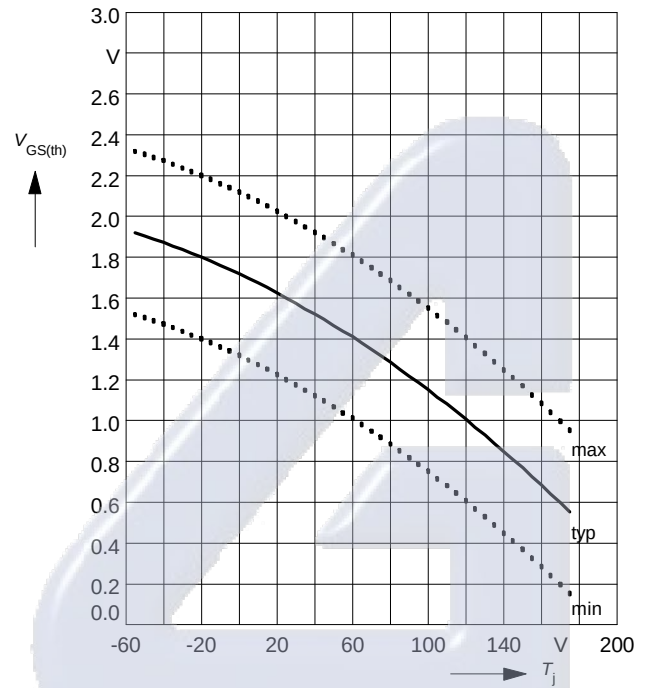
$$R_{DS(on)} = f(T_j)$$

parameter: $I_D = 33\text{ A}$, $V_{GS} = 4.5\text{ V}$

**Gate threshold voltage**

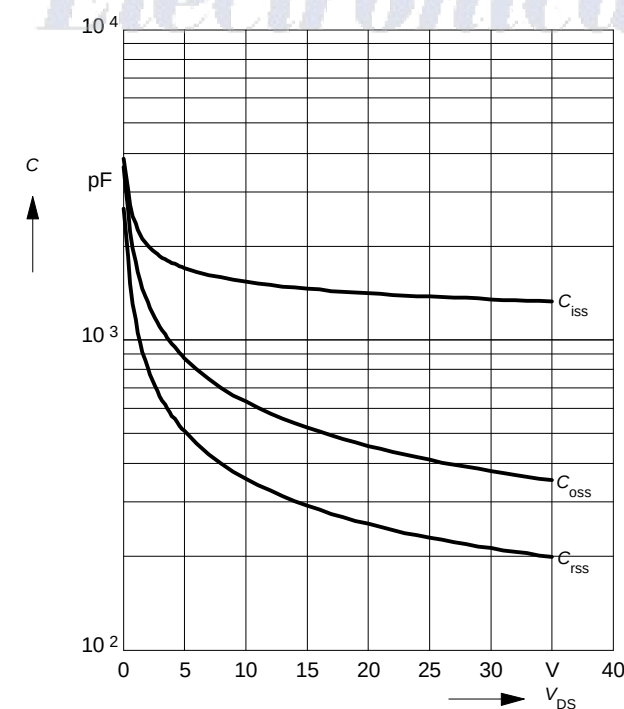
$$V_{GS(th)} = f(T_j)$$

parameter: $V_{GS} = V_{DS}$, $I_D = 90\mu\text{A}$

**Typ. capacitances**

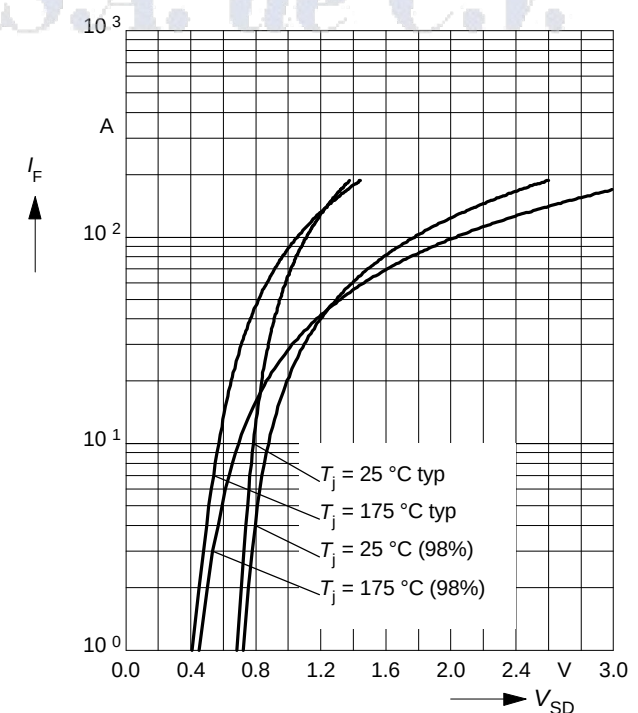
$$C = f(V_{DS})$$

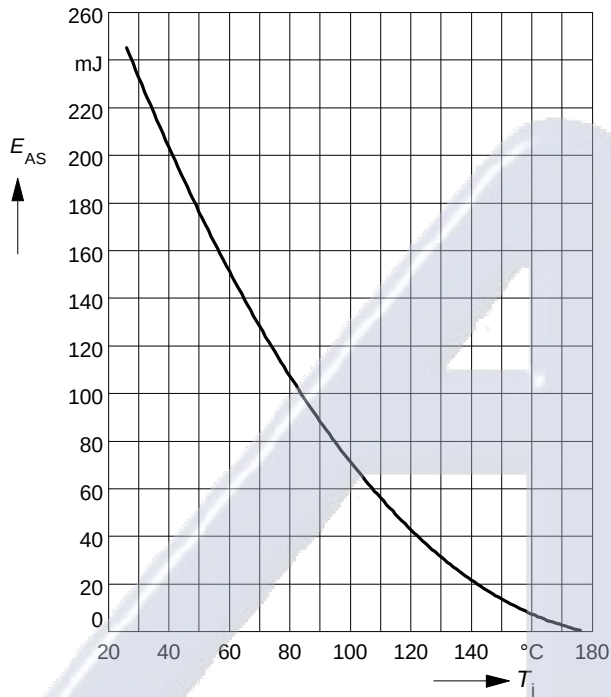
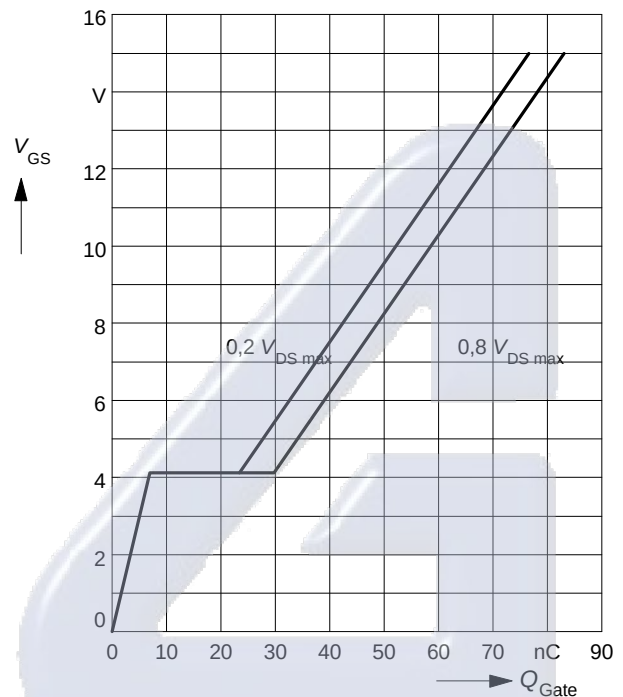
parameter: $V_{GS} = 0\text{ V}$, $f = 1\text{ MHz}$

**Forward characteristics of reverse diode**

$$I_F = f(V_{SD})$$

parameter: T_j , $t_p = 80\mu\text{s}$



SIEMENS**BUZ 102 SL****SPP47N05L****Avalanche energy** $E_{AS} = f(T_j)$ parameter: $I_D = 47\text{ A}$, $V_{DD} = 25\text{ V}$ $R_{GS} = 25\ \Omega$, $L = 222\ \mu\text{H}$ **Typ. gate charge** $V_{GS} = f(Q_{Gate})$ parameter: $I_{D\text{ puls}} = 47\text{ A}$ **Drain-source breakdown voltage** $V_{(BR)DSS} = f(T_j)$ 